

Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Type	Pin Description
1	CLKIN	Input	Reference Clock Input
2	OE	Output	Output Enable. Refer to the Table. 1 for Logic Table
3	CLK1	Output	Buffered Clock Output 1
4	GND	Power	Power Ground.
5	CLK2	Output	Buffered Clock Output 2
6	VDD	Output	3.3V Power Supply
7	CLK3	Power	Buffered Clock Output 3
8	CLK4	Input	Buffered Clock Output 4





General Description

The SL2304NZ is a low skew, jitter and power fanout Buffer designed to produce up to four (4) clock outputs from one (1) reference input clock, for high speed clock distribution, including PCI/PCI-X applications.

Input and output Frequency Range

The input and output frequency is the same (1x) for SL2304NZ-1 and SL2304NZ-1Z and operates from DC to 140MHz clock range with up to 25pF output load.

OE (Output Enable) Function

The only difference between SL2304-1 and SL2304NZ-1Z is the OE logic implementation. When OE=0, SL2404NZ-1 outputs are disabled and outputs are at Logic Low. In the case of SL2304NZ-1Z the outputs are at High-Z. Refer to the Available OE Logic Configuration Table. 1 below.

Output Clock Skew

All outputs should drive the similar load to achieve outputto-output skew and input-to-output delay specifications as given in the switching electrical tables.

Power Supply Range (VDD)

The SL2304NZ is designed to operate 3.3V+/-10% (3.63Vmax to 2.97V-min) VDD power supply range. An internal on-chip voltage regulator is used to provide to constant power supply of 1.8V, leading to a consistent and stable electrical performance in terms of skew and jitter. The SL2304NZ I/O is powered by using VDD.

Refer to SL23EP04NZ products for DC to 220MHz-max frequency range, 2.5V to 3.3V power supply operation, improved skew, jitter and higher drive options.

Contact SLI for 1.8V power supply Fan-Out Buffer and ZDB products.

CLKIN (Pin-1)	OE (Pin-2)	SL2304NZ-1 CLKOUT [1:4]	SL2304NZ-1Z CLKOUT [1:4]
Low	Low	Low	High-Z
High	Low	Low	High-Z
Low	High	Low	Low
High	High	High	High

Table 1. Available SL2304 CLKIN and OE Logic Configurations



Absolute Maximum Ratings (All Products)

Description	Condition	Min	Мах	Unit
Supply voltage, VDD		-0.5	4.6	V
All Inputs and Outputs		-0.5	VDD+0.5	V
Ambient Operating Temperature	In operation, C-Grade	0	70	°C
Ambient Operating Temperature	In operation, I-Grade	-40	85	°C
Storage Temperature	No power is applied	-65	150	°C
Junction Temperature	In operation, power is applied		125	°C
Soldering Temperature			260	°C
ESD Rating (Human Body Model)	JEDEC22-A114D	-4,000	4,000	V
ESD Rating (Charge Device Model)	JEDEC22-C101C	-1,500	1,500	V
ESD Rating (Machine Model)	JEDEC22-A115D	-200	200	V

Operating Conditions (C-Grade and VDD=3.3V)

Unless otherwise stated VDD= 3.3V+/- 10%, CL=15pF and Ambient Temperature range 0 to +70°C

Description	Symbol	Condition	Min	Тур	Мах	Unit
Operating Voltage	VDD	VDD+/-10%	2.97	3.3	3.63	V
Operating Temperature	ТА	Ambient Temperature	0	-	70	°C
Input Capacitance	VIH	Pins 1 and 2	-	3	5	pF
Output Capacitance	CL1	All outputs≤100MHz	-	-	30	pF
Output Capacitance	CL2	All outputs≤140MHz	-	-	15	pF
Input Operating Frequency	CLKIN	Input Clock Range	DC	-	140	MHz
Input Operating Frequency CLKN2		Input Clock Range, CL=30pF	DC	-	100	MHz



DC Electrical Characteristics (C-Grade and VDD=3.3V)

Unless otherwise stated VDD= 3.3V+/- 10%, CL=15pF and Ambient Temperature range 0 to +70°C

Description	Symbol	Condition	Min	Тур	Max	Unit
Input Low Voltage	VINL	CLKIN and OE	-	-	0.8	V
Input High Voltage	VINH	CLKIN and OE	2.0	-	VDD+0.3	V
Input Low Current	IINL	0 < VIN < 0.8V	-5	+/-2	5	μA
Input High Current	IINH	2.4V < VIN < VDD	-5	+/-2	5	μA
	VOL1	lo∟=24mA	-	-	0.80	V
	VOL2	IoL=12mA			0.55	V
Output High Voltage	VOH1	Iон=-24mA	2.0	-	- (V
	VOH1	Іон=-12mA	2.4	-		V
Power Supply Current	IDD1	CLKIN=33MHz CL=0 (No load at outputs)	-	7	11	mA
Power Supply Current	IDD2	CLKIN=66MHz CL=0 (No load at outputs)	-	9	14	mA
Power Supply Current	IDD3	CLKIN=133MHz CL=0 (No load at outputs)		12	18	mA

Switching Electrical Characteristics (C-Grade and VDD=3.3V)

Unless otherwise stated VDD= 3.3V+/- 10%, CL=15pF and Ambient Temperature range 0 to +70°C

Description	Symbol	Condition	Min	Тур	Max	Unit
	FOUT1	CL=15pF	DC	-	140	MHz
Output Frequency Range	FOUT1	CL=30pF	DC	-	100	MHz
Output Rise/Fall Time	tr/f-1	Measured at 0.8V to 2.0V CL=15pF	_	-	2.0	ns
Output Rise/Fall Time	tr/f-2	Measured at 0.8V to 2.0V CL=30pF	-	-	2.4	ns
Input Duty Cycle	DC1	Measured at VDD/2	20	50	80	%
Dutput Duty Cycle DC2		CL=15pF, Fout=140MHz Measured at VDD/2	45	-	55	%
Output Duty Cycle	DC3	CL=30pF, Fout=100MHz Measured at VDD/2	40	-	60	%
Output to Output Skew	SKW1	Measured at VDD/2 and Outputs are equally loaded	_	50	100	ps
Part to Part Skew SKW2		Measured at VDD/2 and Outputs are equally loaded	_	100	200	ps
Propagation Delay Time PDT		Measured at VDD/2 from CLKIN to Output Clock rising edge	1.5	2.5	3.5	ns
Cycle-to-Cycle Jitter	Jitter CCJ1 CLKIN=66MHz and CL=15		_	75	150	ps
Cycle-to-Cycle Jitter	CCJ2	CLKIN=133MHz and CL=15	_	50	100	ps

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Operating Conditions (I-Grade and VDD=3.3V)

Unless otherwise stated VDD= 3.3V+/- 10%, CL=15pF and Ambient Temperature range -40 to +85°C

Description	Symbol	Condition	Min	Тур	Max	Unit
Operating Voltage	VDD	VDD+/-10%	2.97	3.3	3.63	V
Operating Temperature	TA	Ambient Temperature	-40	_ (85	°C
Input Capacitance	VIH	Pins 1 and 2	-	3	6	pF
Output Conscitones	CL1	All outputs≤100MHz	-		30	pF
	CL2	All outputs≤140MHz	-	-	15	pF
Input Operating Frequency	CLKN1	Input Clock Range, CL=15pF	DC		140	MHz
Input Operating Frequency	CLKN2	Input Clock Range, CL=30pF	DC	-	100	MHz

DC Electrical Characteristics (I-Grade and VDD=3.3V)

Unless otherwise stated VDD= 3.3V+/- 10%, CL=15pF and Ambient Temperature range -40 to +85°C

Description	Symbol	Condition	Min 🔷	Тур	Max	Unit
Input LOW Voltage	VINL	CLKIN and OE	-	-	0.8	V
Input HIGH Voltage	VINH	CLKIN and OE	2.0	-	VDD+0.3	V
Input LOW Current	IINL	0 < VIN < 0.8V	-6	+/-3	6	μA
Input HIGH Current	IINH	2.4V < VIN < VDD	-6	+/-3	6	μA
	VOI	IoL=24mA	-	-	0.80	V
Output Low Voltage	VOL	IoL=12mA	-	-	0.55	V
Qutput Lligh Voltage	VOH	Іон=-24mA	2.0	-	-	V
		Іон=-12mA	2.4	-	-	V
Power Supply Current	IDD1	CLKIN=33MHz CL=0 (No load at outputs)	-	8	12	mA
Power Supply Current	IDD2	CLKIN=66MHz CL=0 (No load at outputs)	-	10	15	mA
Power Supply Current	IDD3	CLKIN=133MHz CL=0 (No load at outputs)	_	14	20	mA



Switching Electrical Characteristics (I-Grade and VDD=3.3V)

Unless otherwise stated VDD= 3.3V+/- 10%, CL=15pF and Ambient Temperature range -40 to +85°C

Description	Symbol	Condition	Min	Тур	Max	Unit
Output Frequency Panga	FOUT1	CL=15pF	DC	-	140	MHz
	FOUT2	CL=30pF	DC	-	100	MHz
Output Rise/fall Time	tr/f-1	CL=15pF, measured at 0.8V to 2.0V	-		2.2	ns
Output Rise/Fall Time	tr/f-2	CL=30pF, measured at 0.8V to 2.0V	-	-	2.6	ns
Input Duty Cycle	DC1	Measured at VDD/2	20	ŀ	80	%
Output Duty Cycle	DC2	CL=15pF, Fout=140MHz Measured at VDD/2	45 -		55	%
Output Duty Cycle	DC3	CL=30pF, Fout=100MHz Measured at VDD/2	40	-	60	%
Output to Output Skew	SKW1	Measured at VDD/2 and Outputs are equally loaded	-	60	120	ps
Part to Part Skew	SKW2	Measured at VDD/2 and Outputs are equally loaded	nd _		240	ps
Propagation Delay Time	PDT	Measured at VDD/2 from CLKIN to Output Clock rising edge and Outputs are equally loaded	KIN to Outputs 1.2 2.5		3.8	ns
Cycle-to-Cycle Jitter	CCJ1	CLKIN=66MHz and CL=15	Iz and CL=15 – 80		160	ps
Cycle-to-Cycle Jitter	CCJ2	CLKIN=133MHz and CL=15	-	60	120	ps

External Components & Design Considerations

Typical Application Schematic



Recommendations

Decoupling Capacitor: A decoupling capacitor of 0.1μ F must be used between VDD and VSS pins. Place the capacitor on the component side of the PCB as close to the VDD pin as possible. The PCB trace to the VDD pin and to the GND via should be kept as short as possible. Do not use vias between the decoupling capacitor and the VDD pin.

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Package Outline and Package Dimensions

8-Pin TSSOP (4.4 mm)



Thermal Characteristics

Parameter	Symbol	Condition	Min	Тур	Мах	Unit
	θJA	Still air	-	110	-	°C/W
Thermal Resistance Junction to Ambient	θJA	1m/s air flow	-	100	-	°C/W
	θJA	3m/s air flow	-	80	-	°C/W
Thermal Resistance Junction to Case	θJC	Independent of air flow	-	35	-	°C/W

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Ordering Information ^[1]

Ordering Number	Marking	Shipping Package	Package	Temperature
SL2304NZZC-1	SL2304NZC-1	Tube	8-pin TSSOP	0 to 70°C
SL2304NZZC-1T	SL2304NZC-1	Tape and Reel	8-pin TSSOP	0 to 70°C
SL2304NZZI-1	SL2304NZI-1	Tube	8-pin TSSOP	-40 to 85°C
SL2304NZZI-1T	SL2304NZI-1	Tape and Reel	8-pin TSSOP	-40 to 85°C
SL2304NZZC-1Z	SL2304NZC-1Z	Tube	8-pin TSSOP	0 to 70°C
SL2304NZZC-1ZT	SL2304NZC-1Z	Tape and Reel	8-pin TSSOP	0 to 70°C
SL2304NZZI-1Z	SL2304NZI-1Z	Tube	8-pin TSSOP	-40 to 85°C
SL2304NZZI-1ZT	SL2304NZI-1Z	Tape and Reel	8-pin TSSOP	-40 to 85°C

Notes:

1. The SL2304NZ products are RoHS compliant.



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